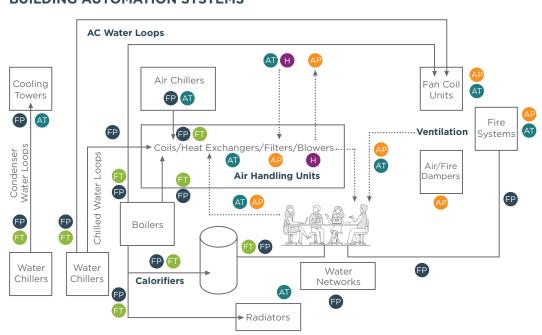


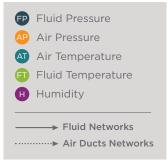
Tightening regulations on efficiency and mounting environmental concerns have driven improvements in building automation systems. Applications in Building Automation include heating, ventilation, air conditioning and refrigeration (HVACR), with control interfaces as well as monitoring and diagnostic systems – all with the help of sensors and connectivity solutions. Sensors provide the data to one or more processing units that uses that information to drive heating and cooling equipment as well as actuators, dampers, fans and other components to control a building's operation. Over time advances in technology have made it possible to greatly increase the number of control points, improved system accuracy and provided the ability to fine tune the system based on occupancy, specific zones as well as outdoor heat loads and much more.

## TE CONNECTIVITY ADVANTAGES

- Sensing Element Portfolio Breadth
- Industrial Technology Leadership
- · Manufacturing Scale
- Customization Capability

## **BUILDING AUTOMATION SYSTEMS**





## **SENSORS FOR BUILDING AUTOMATION SYSTEMS**

Sensor Techno	ology	Application	Key Product Features	Benefits
MS5839		Miniature, high performance and precise embedded sensor for HVAC equipment in harsh environments	MEMS based sensor offering advanced shielding for harsh HVAC environments     Low power consumption and digital interconnectivity in an ultra-compact     Low profile package	Low power consumption to help faciliate IoT applications and condition monitoring practices     Highly precise even in harsh industrial environments
<u>SM9000</u>		Monitoring very low pressure properties for ventilation, VAV and filter monitoring within HVAC systems	Low pressure MEMS transducer technology and CMOS mixed signal processing technology     Pressure and temperature compensated with high accuracy and repeatability	Accurate, reliable and repeatable operation over the life of the part     The pressure sensor can be mounted directly onto a standard PCB     Compensation and calibration eliminates need for additional circuitry or separate calibration
<u>SM7000</u>		Monitoring low air pressure within ventilation systems	Low pressure MEMS transducer technology and CMOS mixed signal processing technology to produce either an analog and/or digital output fully conditioned     Multi-order pressure and temperature compensated	Accurate, reliable and repeatable operation over the life of the part     The pressure sensor can be mounted directly onto a standard PCB     Compensation and calibration eliminates need for additional circuitry or separate calibration
HCLA	inter	Measure low pressure properties within HVAC systems	Miniature calibrated and temperature compensated low pressure sensors that perform precision digital signal conditioning and provide analog and digital output at the same time	Space-saving sensor packaging for PCB-mounting and maximum OEM design flexibility     Special compensation technique to achieve very high offset stability and virtually no position sensitivity
LMI		Monitors extremely low pressure of VAVs     Filter monitoring     Burner control and other areas of the HVAC system	Extremely low full scale pressure range     Accuracy is a percent of reading not a percent of full scale     Provides temperature and humidity data also     I'C output only	High immunity to dust     Extremely high accuracy at very low pressures     Longterm stability     Small footprint and low profile for space savings
LHD		Large dynamic range monitoring found in airflow applications within VAVs     Filter monitoring     Burner control and other areas of the HVAC system	Extremely low full scale pressure range     Accuracy is a percent of reading not a percent of full scale     Provides temperature and humidity data also     I <sup>2</sup> C output only	High immunity to dust     Extermely high accuracy at very low pressures     Low profile surface
MS8607	2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 -	Digital sensor is optimal for applications in which key requirements such as ultra low power consumption and high PHT accuracy, such as in HVAC	Integrated pressure     Humidity and temperature sensor     Compact sensor packaging      2C interface	Product is well suited for applications with ultra low power consumption High PHT accuracy Compact Multi-sensing design
MSP100		Water leak detection or pressure monitoring     Single piece construction     Suitable for harsh environments	Digital output pressure transducer     Stainless steel media compatibility     Low cost     Small profile solution	Very compact, compatible with harsh media and suitable for harsh environments and freeze/thaw applications
M3200	Per	Compact industrial pressure transducer suitable for measurement of gas pressure, refrigerants, and media such as contaminated water, steam, and mildly corrosive fluids	Rugged Microfused design     Variety of ports     Analog or digital output configurations     17-4PH stainless wetted surfaces     Low cost	Compact Customizable Weatherproof CE Compliant
TSYS Series	•	Providing accurate temperature data for HVAC applications	Ultra compact     Digital temperature sensor that provides factory calibrated highly accurate temperature data	Very small and have low thermal mass which provides a quick response to temperature changes Ideal for mobile and battery power applications
SERIES II DISCRETE NTC THERMISTORS		Temperature sensing, control and compensation within HVAC applications	Thermally conductive epoxy coated thermistor  ANG Solid Silver-Plated Copper Leads with White PTFE Insulation Four Temperature Tolerance Classifications Available ROHS Compliant	Rapid time response     Proven stability and reliability     Interchangability     PTFE insulated lead wires
<u>НТU21</u>		Humidity and temperature combination sensors for HVAC applications	Calibrated, linearized signals in digital I <sup>2</sup> C format Humidity and temperature plug and play transducers Direct interface with a micro-controller with the module for humidity and temperature digital outputs Low power sensor	Relative Humidity and Temperature Digital Output, I <sup>2</sup> C interface; low power consumption for IoT applications; fast response time; Full interchangeability with no calibration required in standard conditions
HTU31		Humidity and temperature combination sensors for HVAC applications	High performance humidity and temperature combination sensor     Compact and accurate     Available in digital and analog versions	Provides fast response time Precision measurement Low hysteresis and sustained performance even in the harshest environments

## SENSORS FOR BUILDING AUTOMATION SYSTEMS

HTU35	Mer.	Humidity and temperature combination sensors for HVAC applications	High performance humidity and temperature combination sensor     Compact and accurate     Analog output	Relative Humidity and Temperature analog output Low power consumption Fast response time - Full interchangeability with no calibration required in standard conditions
HTG35	The second	Humidity and temperature combination sensors designed for high volume and demanding applications where power consumption is critical	Humidity and temperature plug and play transducers     Direct interface with a micro-controller with the module for humidity linear voltage and direct NTC outputs     Low power sensor	Suitable for small bulk assemply     ROHS compliant     Full interchangeability     Demonstrated reliability and long term stability     Reliability not affected by repeated condensation
KMT	**	Position sensing for motor motion control within HVAC applications	Magnetic non-contact     360° range     Low cost	Ideal for harsh environments     Contactless absolute angular measurement
KMXP	and the state of t	Contactless linear or angular position measurement in applications like industrial HVAC equipment	Sensor that performs well, even when exposed to oil, dirt and dust     Provide reliable and accurate measurements in harsh environments including high temperatures	Superior performance even within harsh industrial environments     High resolution and high precision with contactless measurement
820M1	The County of th	Accelerometer designed for embedded condition monitoring and predictive maintenance applications	Low cost; board mountable accelerometer     Designed and qualified for machine health monitoring and has superior resolution, dynamic range and bandwidth to MEMS devices.	Proven track record for offering the reliable and long-term stable output required for condition monitoring applications
<u>830M1</u>		Embedded Piezoelectric (PE) accelerometer offering advanced acceleration sensing for machine health monitoring	Embedded Piezoelectric (PE) accelerometer offering advanced acceleration sensing     Wide bandwidth     Small size     Low power, and robust performance are essential	Optimized for critical machine health monitoring the 830M1 offers an outstanding measurement bandwidth (up to 15 kHz) Superior resolution and is designed with highly stable PE sensing technology, to provide long-term, reliable, stable and accurate performance for condition monitoring applications in harsh environments
8911		Wireless accelerometer sensor for Proof of concept (POC) is designed for vibration monitoring in applications such as predictive maintenance and condition monitoring	Compact     LoRaWAN™     Wireless accelerometer for POC with edge computing for condition monitoring     Corrosion resistant stainless steel case and plastic covering	Rugged, IP66 rated O-ring seal allows the sensor to perform well in harsh environments     Piezo sensing element which has the advantage of high bandwidth and ultra low power vs MEMS solutions     Longer battery life of up to 10 years and ultra low sleep power usage
8711-01		Shielded rugged IEPE accelerometers designed for industrial condition monitoring	Available in four standard dynamic ranges from ±5g to ±80g     Wide bandwidth up to greater than 10kHz     Designed to operate in ambient temperature ranges from -55°C to +125°C	Rugged, IP67 rated seal allows the sensor to perform well in harsh environments     Piezo sensing element which has the advantage of high bandwidth and ultra low power vs MEMS solutions



